Features

- 0.8A Low-Dropout Voltage Regulator
- Ultra Low Dropout Voltage
 Typically 100mV at 0.8A Output Current
- High Output Accuracy over Line, Load and Temperature
- Build-In Soft-Start
- Excellent startup under load from 0 to 0.8A
- Power-On-Reset Monitoring on Both V_{DD} and V_{IN} Pins
- Power-OK Output function
- Foldback over Current Protection and Thermal shutdown
- 0.1µA (typ) Shutdown Supply Current
- Low ESR Output Capacitor(Multi-layer Chip Capacitors (MLCC)) Applicable
- Vout Pull Low Resistance when Disable
- TDFN8-2x2
- Green Product (RoHS, Lead-Free, Halogen-Free Compliant)

Applications

- Notebook PC Applications
- Motherboard Applications
- Low Voltage Logic Supplies ¿
- Microprocessor and Chipset Supplies
- Graphic Cards
- Cordless phones

General Description

The GS7168 can deliver up to 0.8A of output current with a typical dropout voltage of only 100mV using internal n-channel MOSFETs. The linear regulator uses a separate VDD supply to power the control circuitry and drive the Internal n-channel MOSFETs. The output voltage is adjustable from 0.8V to the voltage that is very close to V_{IN} .

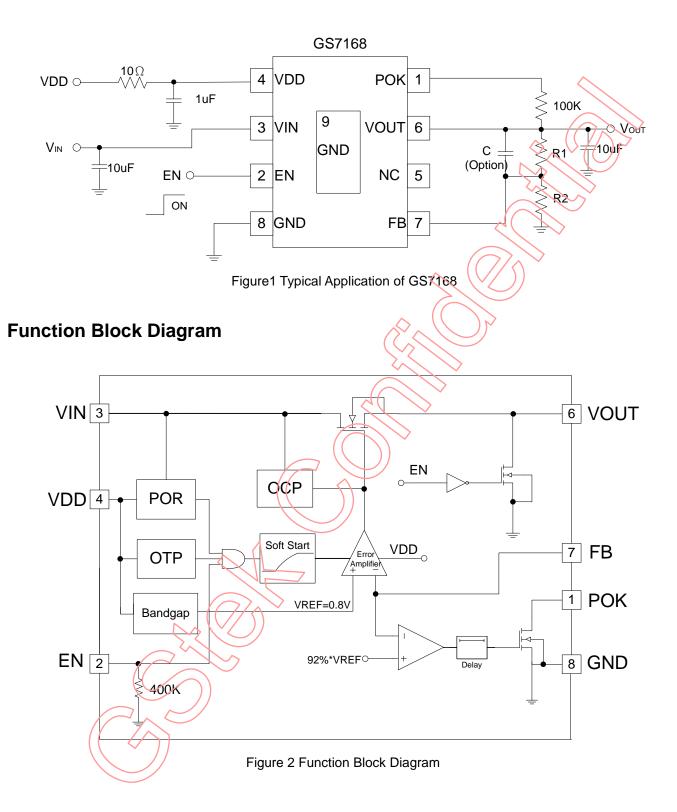
The GS7168 allows the use of low-ESR ceramic capacitor as low as 10uF. Moreover the IC provides good performance on both line transient response and load transient response.

The GS7168 provides foldback over current limit and thermal shutdown to prevent the linear regulator from damage. Built-in soft-start minimizes stress on the input power source by reducing capacitive inrush current on start-up. During start-up, POK remain low until the output reaches 92% of its rating value.

The GS7168 is available in TDFN8-2X2 package.

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Typical Application



Pin Configuration

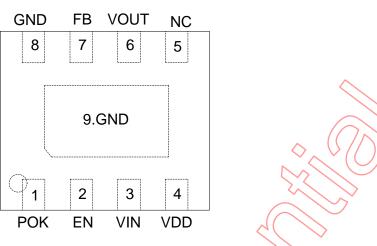


Figure 3 TDFN8-2x2 package

Pin Descriptions

Pin No.	Name	I/O type	Pin Function		
TDFN8-2x2					
1	POK	0	Open drain output. Setting high impedance once V _{OUT} reaches 92% of its rating voltage		
2	EN	Ι	Chip Enable (active high). The device will be shutdown if this pin is pull low.		
3	VIN	I	Input Voltage. Large bulk capacitance should be placed closely to this pin. A 10µF ceramic capacitor is recommended at this pin.		
4	VDD	I	Supply voltage for control circuit. VDD is recommend from 3V to 5V and should be 1.5V higher than the output voltage		
5	NC				
6	VOUT	0	Output Voltage. The power output of the device.		
7	FB		Feedback Voltage. This pin is connected to the center tap of an external resistor divider network to set the output voltage as $V_{OUT} = 0.8^{*}(R1+R2)/R2$.		
8、9	GND	1/0	Ground		

Ordering Information

GS7168TD-R 1. Package

No	Item	Contents
1	Package	TD: TDFN8-2x2
2	Shipping	R: Tape & Reel

Example: GS7168 TDFN8-2x2 Tape & Reel ordering information is "GS7168TD-R"

Absolute Maximum Rating (Note 1)

Parameter	Symbol	Limits	Units
Supply Voltage	V _{IN}	-0.3 < V _{IN} < 6.5	V
Control Voltage	V _{DD}	-0.3 < V _{DD} < 6.5	V
Output Voltage	V _{OUT}	-0.3 < V _{OUT} < 5	V
EN, FB, POK		-0.3 < (V _{EN,} V _{FB,} V _{POK}) < 6.5	V
Package Power Dissipation at $T_A \leq 25^{\circ}C$	P _{D_TDFN8-2x2}	822	mW
Junction Temperature	TJ	- 45 ~ 150	°C
Storage Temperature	T _{STG}	- 65 ~ 150	°C
Lead Temperature (Soldering) 10S	T_{LEAD}	260	°C
ESD (Human Body Mode) (Note 2)	$V_{ESD_{HBM}}$	2K	V
ESD (Machine Mode) (Note 2)	$V_{\text{ESD}_{\text{MM}}}$	200	V

Thermal Information (Note 3)

Thermal Information (Note 3)		
Parameter	Symbol	Units
Thermal Resistance Junction to Ambient	θ _{JA_TDFN82X2} 121.6	°C/W
Thermal Resistance Junction to Case	θ _{JC_TDFN8-2x2} 53	°C/W

Recommend Operating Condition (Note 4)

Parameter	Symbol	Limits	Units
Supply Voltage	V _{IN}	$1.0 < V_{IN} < Min\{5.2V, V_{DD}\}$	V
Control Voltage (Note 5)	V _{DD}	$3.0 < V_{DD} < 5.5$	V
Junction Temperature	TJ	- 40 ~ 125	°C
Ambient Temperature	T _A	-40 ~ 85	°C

Electrical Characteristics

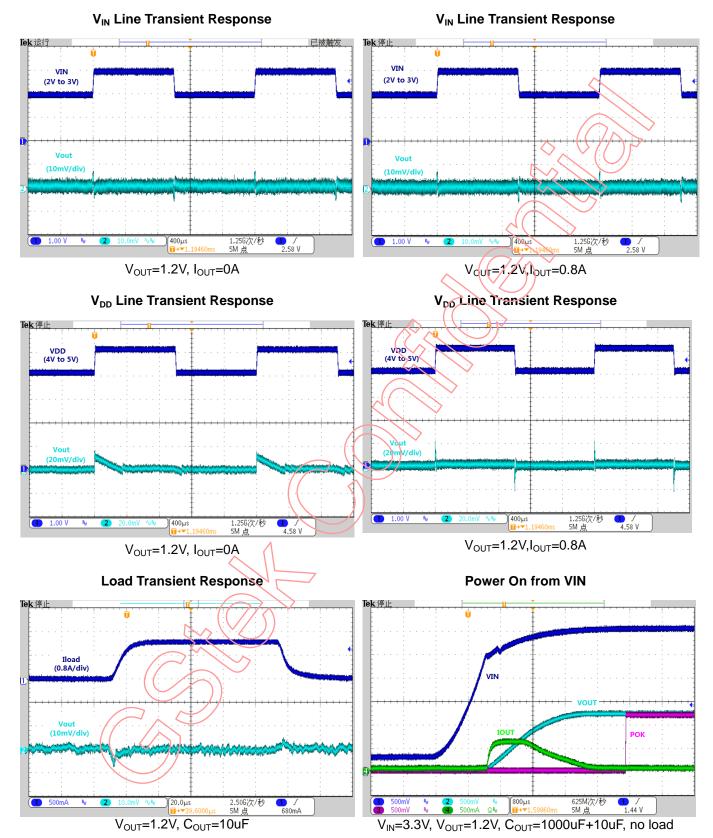
 $(V_{IN} = V_{OUT} + 0.5V, V_{EN} = V_{DD} = 5V, C_{IN} = C_{OUT} = 10uF, T_A = T_J = 25^{\circ}C)$

Parameter	Symbol	Conditions	Min.	Тур.	Max.	Units	
Supply Voltage Section	Supply Voltage Section						
V _{DD} Operation Voltage Range	V _{DD}	V _{DD} Input Range, V _{OUT} =V _{REF}	3.0		5.5	V	
V _{IN} Operation Voltage Range	V _{IN}	V_{IN} Input Range, V_{OUT} = V_{REF}	1.0		Min{5.2 V,VDD}	> v	
SQuiescent current	l _Q	$V_{DD}=V_{IN}=V_{EN}=5V,I_{OUT}=0A,$ $V_{OUT}=V_{REF}$		7.O		mA	
VDD Input current	I _{VDD}	V _{DD} =V _{IN} =V _{EN} =5V, I _{OUT} =0A, V _{OUT} =V _{REF}	<	1.0		mA	
Control Input Current in Shutdown	I _{VDD_SD}	$V_{DD}=V_{IN}=5.0V$, $I_{OUT}=0A$, $V_{EN}=0V$	()	1.0		uA	
V _{DD} POR Threshold	V _{DDRTH}			2.7		V	
V _{DD} POR Hysteresis			5	0.2		V	
V _{IN} POR Threshold	V _{INRTH}	(S)		0.75		V	
V _{IN} POR Hysteresis			\diamond	0.20		V	
Output Voltage		400	•				
Reference Voltage	V _{REF}	IOUT=1mA, VOUT=VREF	0.784	0.8	0.816	V	
Output Voltage Accuracy			-2.0		+2.0	%	
Line Regulation (V_{DD})	$\Delta V_{\text{LINE}_{\text{VDD}}}$	V _{DD} =4V to 5V, I _{OUT} =1mA, V _{OUT} =V _{REF} , V _{IV} =2V		0.03		%	
Line Regulation (V_{IN})	$\Delta V_{\text{LINE}_{\text{IN}}}$	V _{IN} =1.2V to 5V, I _{OUT} =1mA, V _{OUT} =V _{REF}		0.01		%	
Load Regulation	∆ V _{LOAD} (Note 6)	$I_{\text{OUT}}=1$ A to 0.8 A, $V_{\text{OUT}}=V_{\text{REF}}$		0.1		%	
V _{OUT} Pull Low Resistance		V _{DD} =V _{IN} =5.0V, V _{EN} =0V		130		Ω	
Dropout Voltage	<u> </u>						
Dropout Voltage (Note 7)	VDROP	V _{OUT} =V _{REF} , I _{OUT} =0.8A		100		mV	
Protection							
Current Limit	ILIM	$V_{DD}=V_{IN}=V_{EN}=5V, V_{OUT}=V_{REF}$		1.6		А	
Short Circuit Current		V _{OUT} <0.2V		100		mA	
Thermal Shutdown Temperature	T _{SD}	T _J Rising		170		°C	
Thermal Shutdown Returned Temperature				120		°C	

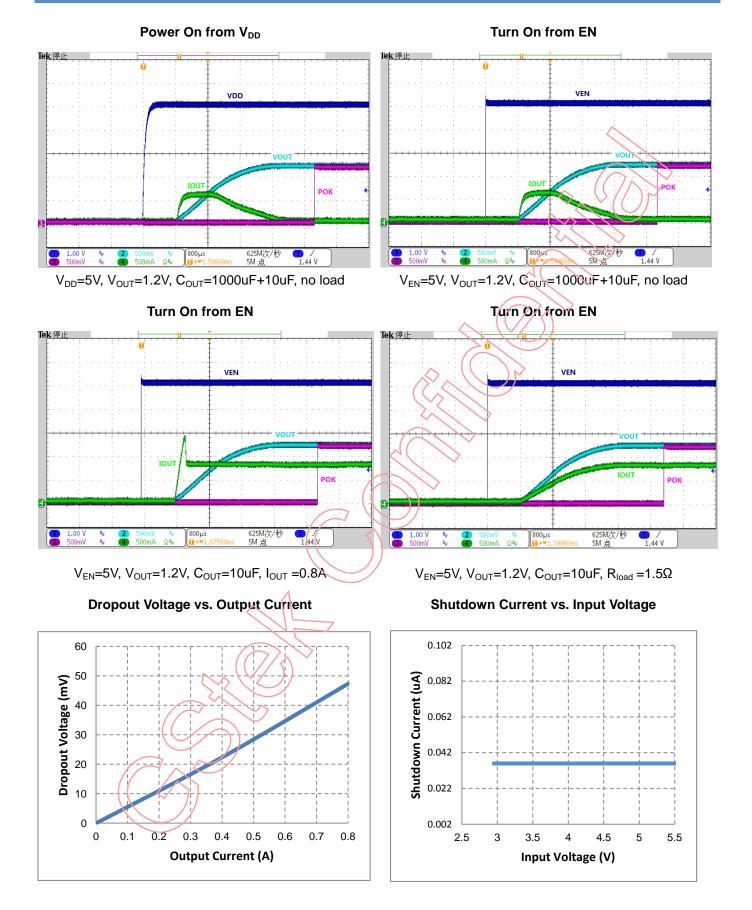
Enable							
EN	Logic-Low Voltage		V _{DD} =5V			0.4	V
Threshold	Logic-High Voltage		V _{DD} =5V	1.2			V
EN Input Bias Current		I _{EN}	V _{EN} =5V		12	\langle	uA
Power Good							
PGOOD Rising Threshold			V _{REF} Rising		92		%
PGOOD Hysteresis			V _{REF} falling		82		%
PGOOD Sink Capability			I _{PGOOD} =5mA		0.2	2	V
PGOOD Dela	ау		-40°C ~125°C	2	1.7	>	mS

- Note 1. Stresses listed as the above "Absolute Maximum Ratings" may cause permanent damage to the device. These are for stress ratings. Functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may remain possibility to affect device reliability.
- Note 2. Devices are ESD sensitive. Handling precaution recommended.
- **Note 3.** θ_{JA} is measured in the natural convection at $T_A=25^{\circ}$ C on a high effective thermal conductivity test board (4 Layers, 2S2P) of JEDEC 51-7 thermal measurement standard. The case point of θ_{JC} is on the expose pad for TDFN8-2x2 package.
- Note 4. The device is not guaranteed to function outside its operating conditions.
- Note 5. VDD should be 1.5V higher than the output voltage, VDD> 1.5V+Vout
- **Note 6.**Regulation is measured at constant junction temperature by using a 2ms current pulse. Devices are tested for load regulation in the load range from 1mA to 0.8A.
- **Note 7.** The Dropout voltage is defined as V_{IN} - V_{OUT} , which is measured when V_{OUT} is 0.98* $V_{OUT(NORMAL)}$. The dropout voltage is measured at constant junction temperature by using a 2ms current pulse.

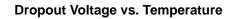
Typical Characteristics

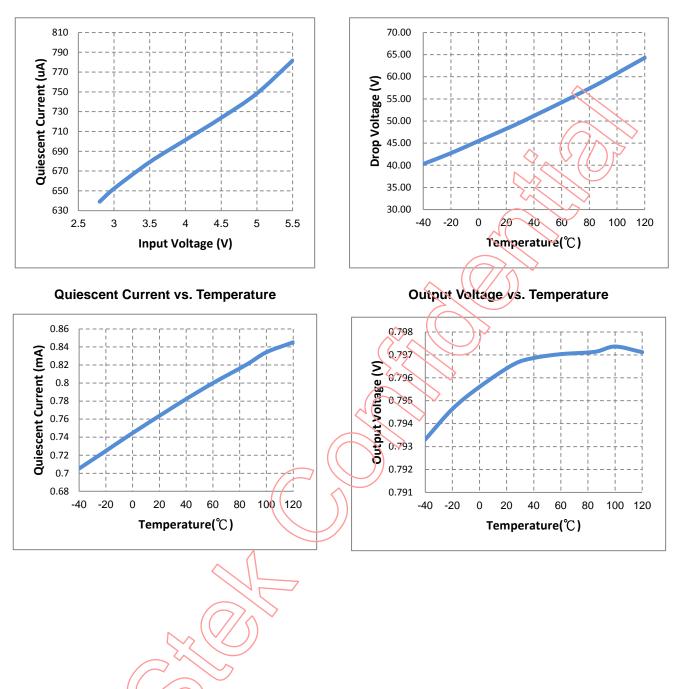


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Quiescent Current vs. Input Voltage





Application Information

Enable

The GS7168 has a dedicated enable pin(EN). When the EN pin is in the logic low (V_{EN} <0.4V), the regulator will be turned off, reducing the supply current to less than 1uA.

When the EN pin is in the logic high (V_{EN} >1.2V), the regulator will be turned on and undergoes a new soft-start cycle. Left open, the EN pin is pulled down by a internal resistor to shut down the regulator.

Power-on-Reset

The GS7168 features a power-on-reset control through monitor both input voltages to prevent wrong operations. Only after the two supply voltages exceed their rising POR threshold voltages, the regulator is to be initiated and starts up.

POK

The POK pin is an open-drain output, and can be connects to V_{OUT} or other rail through an external pull-up resistor. As the output voltage arrives 92% of normal output voltage, an internal delay function starts to perform a delay time and then output the POK pin high to indicate the output is OK. As the output voltage falls below the falling Power-OK threshold or one of the two supply voltages falls below it's falling POR threshold, the POK pin will output low immediately without a delay time.

Build-In Soft-Start

An internal soft-start function controls rise rate of the output voltage to limit the current surge at start-up. The typical soft-start interval is about 1.5mS.

Current Limit

The GS7168 contains a foldback over current protection function. It allows the output current to

reach the maximum value of 1.6A. Then further decreases in the load resistance reduce both the load current and the load voltage. The main advantage of foldback limiting is less power dissipation in the pass transistor under shortedload conditions. During startup, the current limit value is set to a high value, thus GS7168 can operate in full load condition. After startup, the current limit value is set to a normal value, so the pass transistor can be protected well.

Thermal-Shutdown Protection

Thermal Shutdown protects GS7168 from excessive power dissipation. If the die temperature exceeds 170°C, the pass transistor is shut off. 50°C of hysteresis prevents the regulator from turning on until the die temperature drops to 120°C.

Output Capacitor selection

The GS7168 is specifically designed to employ ceramic output capacitors as low as 10uF. Place the capacitors physically as close as possible to the device with wide and direct PCB traces. Capacitor ESR should be less than 50mohm.

Feedback Network

Figure 4 shows the feedback network. For Coption NC application, The suggested design procedure is to choose R2=100K Ω .

V _{OUT}	R1(R2=100KΩ)	C _{OPTION}	
0.8V ~ 3.6V	0 ~ 300 KΩ	NC	

Table 1. R2=100KΩ

For R2>10K Ω application, The suggested design procedure is to choose table2.

V _{OUT} R1(R2=10KΩ)	C _{OPTION}
3V ~ 1.6V 0 ~ 10 KΩ	470pF~1nF
6V ~ 2.4V 10 KΩ ~ 20 KΩ	100pF~500pF
V ~ 3.6V 20 KΩ ~ 30 KΩ	20pF~300pF
	•

Table 2. R1=10KΩ

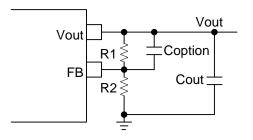


Figure 4 Feedback Network

Input Capacitor selection

Bypass VIN to ground with a 10uF or greater capacitor. Bypass VDD to ground with a 1uF capacitor for normal operation in most applications. Ceramic, tantalum or aluminum electrolytic capacitors may be selected for input capacitor. However ceramic capacitors are recommended due to their significant cost and space savings. Place the capacitors physically as close as possible to the device with wide and direct PCB traces.

Power Dissipation and Layout Considerations

Although internal thermal limiting function is integrated in GS7168, continuously keeping the junction near the thermal shutdown temperature may possibly affect device reliability. For continuous operation, it is highly recommended to keep the junction temperature below the maximum operation junction temperature 125°C for maximum reliability.

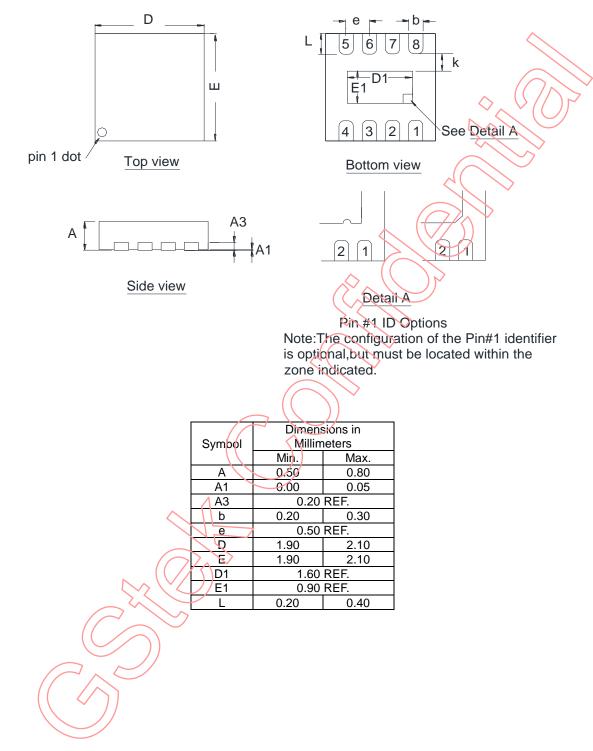
The power dissipation definition in device is:

 $\mathsf{P}_\mathsf{D} = (\mathsf{V}_\mathsf{IN} - \mathsf{V}_\mathsf{OUT}) \ge \mathsf{I}_\mathsf{OUT} + \mathsf{V}_\mathsf{DD} \ge \mathsf{I}_\mathsf{Q}$

The maximum power dissipation can be calculated as:

Where $T_{J(MAX)}$ is the maximum operation junction temperature 125°C, T_A is the ambient temperature and the θ_{JA} is the junction to ambient thermal resistance.

Package Dimensions, TDFN8-2x2



1. Min.: Minimum dimension specified.

Note:

- 2. Max.: Maximum dimension specified.
- 3. REF.: Reference. Normal/Regular dimension specified for reference.

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